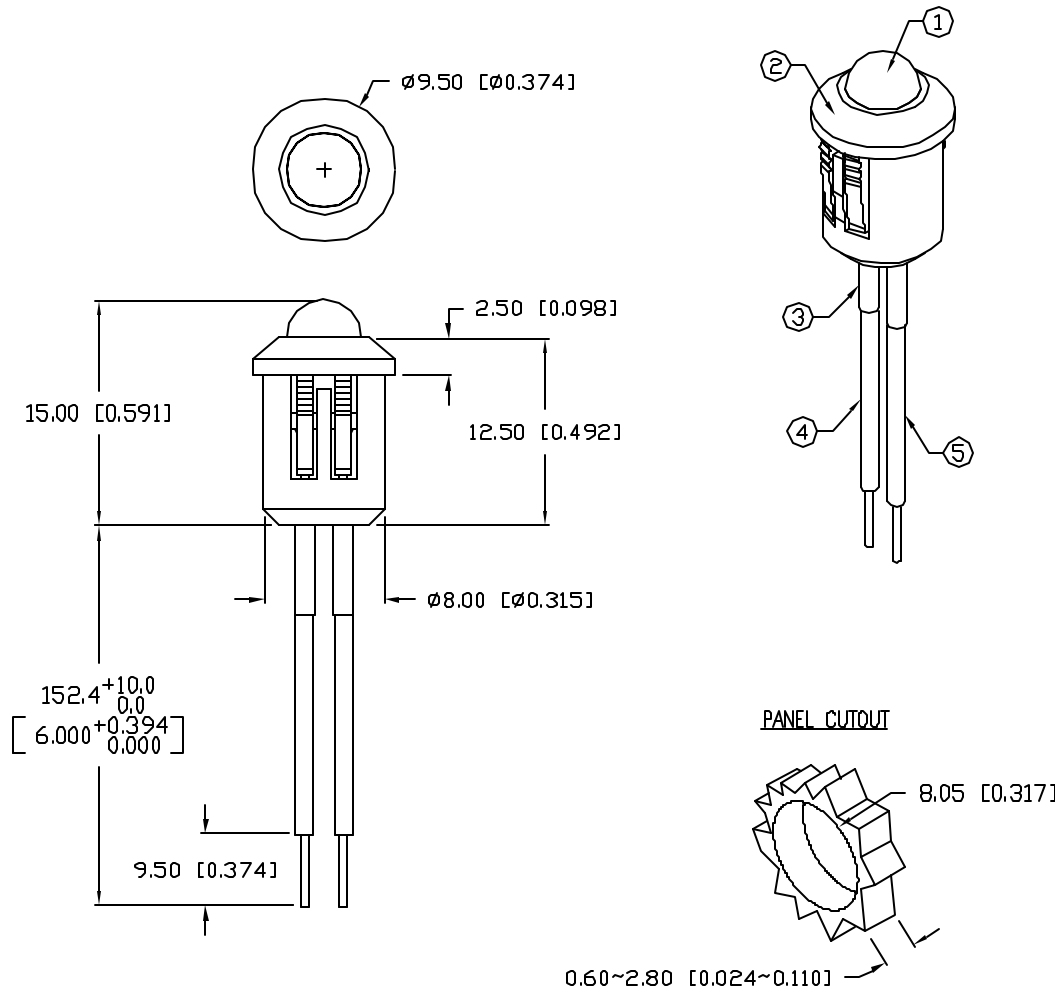


CAUTION: PRESSURE SENSITIVE ASSEMBLY  
AVOID APPLYING PRESSURE TO LED  
DURING PANEL ASSEMBLY.



ELECTRO-OPTICAL CHARACTERISTICS  $T_A=25^\circ\text{C}$   $I_f=20\text{mA}$

PARAMETER	MIN	TYP	MAX	UNITS	TEST COND
PEAK WAVELENGTH		590		nm	
FORWARD VOLTAGE		2.1	2.5	$V_f$	
REVERSE VOLTAGE	5.0			$V_r$	$I_r=100\mu\text{A}$
AXIAL INTENSITY		300		med	$I_f=20\text{mA}$
VIEWING ANGLE		60		2x theta	
EMITTED COLOR:	YELLOW				
EPOXY LENS FINISH:	YELLOW DIFFUSED				

LIMITS OF SAFE OPERATION AT  $25^\circ\text{C}$

PARAMETER	MAX	UNITS
PEAK FORWARD CURRENT*	150	mA
STEADY CURRENT	30	mA
POWER DISSIPATION	105	mW
DERATE FROM $25^\circ\text{C}$	-1.2	mW/ $^\circ\text{C}$
OPERATING, STORAGE TEMP.	-40 TO +85	$^\circ\text{C}$

\*  $t < 10\mu\text{s}$

NOTES:

1. SSL-LX5093SYD, YELLOW LED. TRIM LEADS TO 3-4mm.
2. SSH-RTF5010, BLACK HOLDER.
3. LXP-HEATSHRINK-2, (2 PCS.)  $1/16" \times 1/2"$ .
4. ANODE LEAD: LXP-WST24RDTQC, CUT 160mm LONG, STRIP ENDS 3mm & 9.5mm.
5. CATHODE LEAD: LXP-WST24BLTQC, CUT 160mm LONG, STRIP ENDS 3mm & 9.5mm.

\*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECIMAL PRECISION ARE: X=±1 (±0.039), XX=±0.5 (±0.020), XXX=±0.25 (±0.010), XXXX=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.002), LEAD LENGTH=±0.75 (±0.030), MIN=  $\begin{matrix} +\text{DECIMAL PRECISION} \\ -0.00 \end{matrix}$  MAX=  $\begin{matrix} +0.00 \\ -\text{DECIMAL PRECISION} \end{matrix}$

REV.

PART NUMBER

SSI-LXR5010SYD-150

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T-5mm, 590nm AlInGaP YELLOW LED PANEL INDICATOR,  
YELLOW DIFFUSED LENS, 6" WIRE LEADS.

RELIABILITY NOTE  
OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.

DRAWN BY:

BC

CHECKED BY:

APPROVED BY:

DATE: 1.5.02

PAGE: 1 OF 1

SCALE: N/A